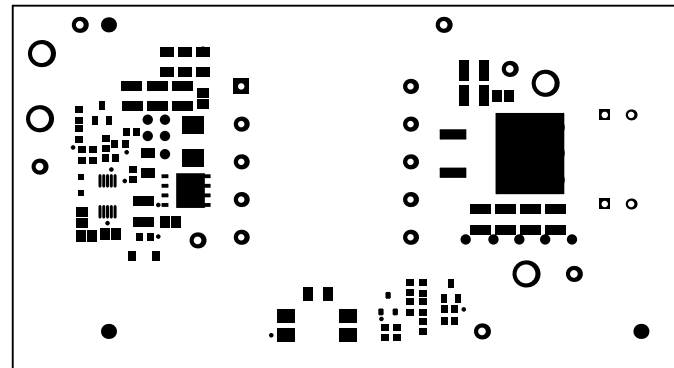
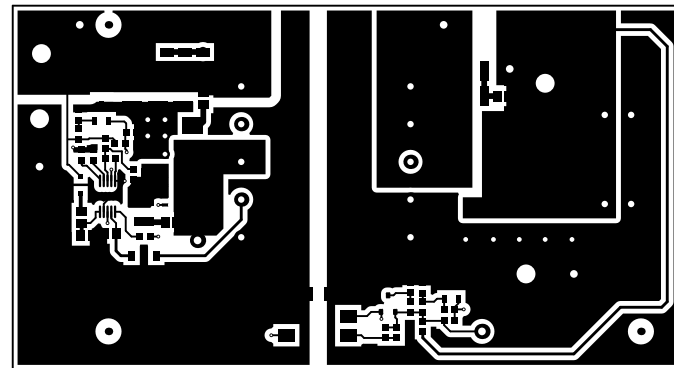


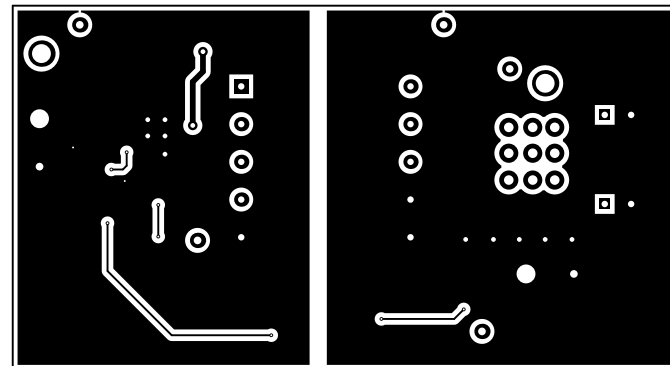
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP20551		
PLOT NAME = Top Overlay	GENERATED : 1/24/2017 7:17:25 PM	TEXAS INSTRUMENTS	



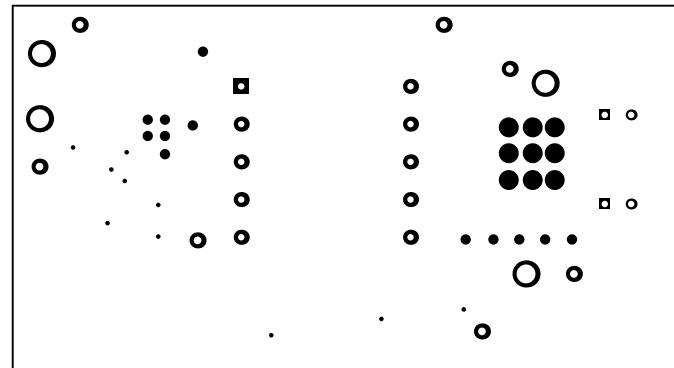
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP20551		
PLOT NAME = Top Solder Mask	GENERATED : 1/24/2017 7:17:26 PM	TEXAS INSTRUMENTS	



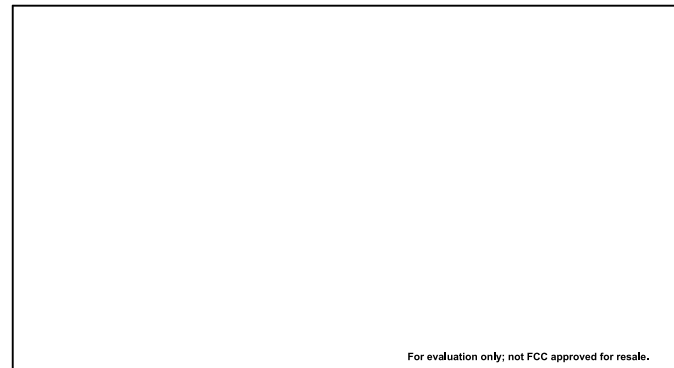
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP20551		
PLOT NAME = Top Layer	GENERATED : 1/24/2017 7:17:27 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP20551		
PLOT NAME = Bottom Layer	GENERATED : 1/24/2017 7:17:27 PM	TEXAS INSTRUMENTS	

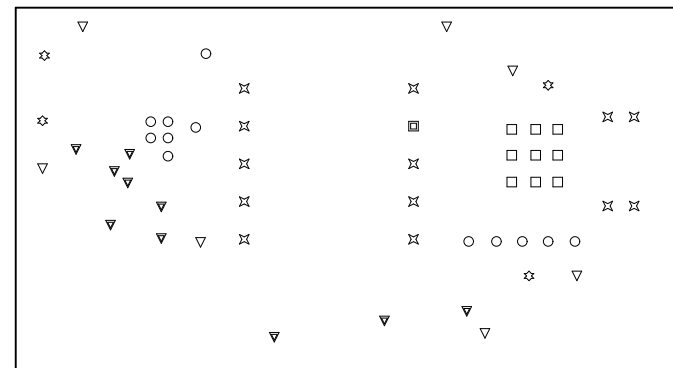


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP20551		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/24/2017 7:17:28 PM	TEXAS INSTRUMENTS	

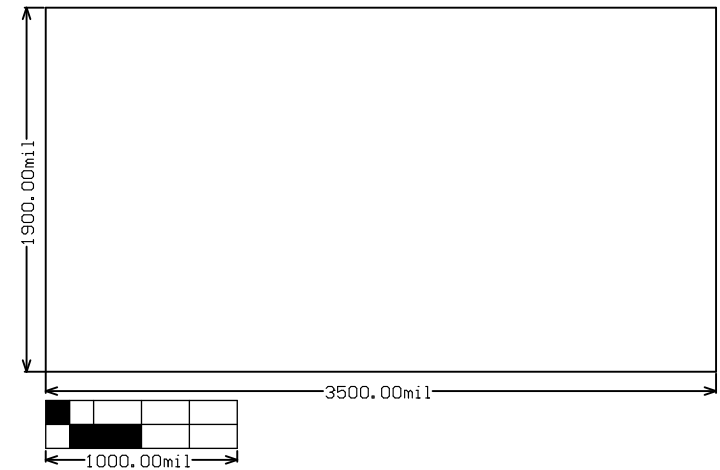


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP20551		
PLOT NAME = Bottom Overlay	GENERATED : 1/24/2017 7:17:29 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	10	10.00mil (0.254mm)	PTH	Round
○	12	25.00mil (0.635mm)	PTH	Round
✕	13	33.46mil (0.850mm)	PTH	Round
■	1	33.54mil (0.852mm)	PTH	Round
▽	7	40.00mil (1.016mm)	PTH	Round
□	9	50.00mil (1.270mm)	PTH	Round
☆	4	98.43mil (2.500mm)	PTH	Round
	56 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP20551		
PLOT NAME = Drill Drawing	GENERATED : 1/24/2017 7:17:30 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20551	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP20551		
PLOT NAME = Board Dimensions	GENERATED : 1/24/2017 7:17:31 PM	TEXAS INSTRUMENTS	

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